

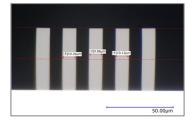
# SU-8 3000CF-05A DFR, Photosensitive Permanent Epoxy Dry Film

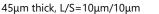
## **MATERIAL DESCRIPTION**

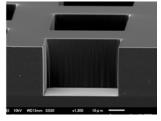
SU-8 3000CF-05A DFR is a photosensitive permanent negative tone dry film resist. Utilizing a low halogen epoxy resin and antimony-free formulation. SU-8 3000CF-05A DFR enables the fabrication of chemically and thermally stable structures. Such as support walls and capping layers for SAW & BAW Filter cavity packages, MEMS sensors and microfluidic devices.

#### **KEY FEATURES**

- Antimony-Free
- ■Low Halogen (Total Chlorine < 900 ppm)
- Excellent Resolution and Aspect Ratio (>3:1)
- ■Excellent Thermal Stability
- ■Low Process Temperature
- ■Low Water Absorption
- ■High Modulus (2.3Gpa @175°C)



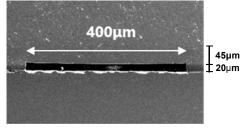




20μm thick, 50μm square hole

### **MATERIAL PROPERTIES**

Property	Unit	Value
Glass Transition Temperature (DMA)	°C	344
Thermal Stability (5% wt. loss temp. in Air)	°C	390
Adhesion Strength (Shear strength on Si)	MPa	55
Young's Modulus (at 25°C)	GPa	2.9
Storage Modulus (at 30°C, DMA)	GPa	3.2
Storage Modulus (at 175°C, DMA)	GPa	2.3
Water Absorption (85°C/85% RH for 24 hr)	%	0.4



400 μm Width Cavity Structure.

## **Wall PROCESS GUIDLINES**

Step	45μmWall Layer	Wall PROCESS FLOW	
Lamination	DXL2 series, Teikoku Taping System	Pretreat Substrate	
- Roll Temp.	40°C	Peel Cover Film	
- Stage Temp.	60°C	Laminate	
- Speed	5 mm/sec	Peel Support Film	
- Pressure	600 kPa		
Post Lamination Bake (on Hot-plate)	150°C10min	Post Lamination Bake	
Exposure	200 mJ/cm2 (@365nm) (To obtain vertical sidewalls we recommend the use	Expose (i-line)	
	of a long-pass Optical Filter. Eliminating <350nm UV radiation)	Post Exposure Bake (PEB)	
PEB (on Hot-Plate)	45 °C / 5min + 55°C / 5min + 95 °C / 10min	Develop	
Development	Solvent Development : PGMEA 10min	Rinse and Dry	
Hard-Bake (in Oven)	60min @180°C	↓ Hard Bake	

#### **Roof PROCESS GUIDLINES**

Step	45μmRoof Layer	Roof PROCESS FLOW	
Lamination	DXL2 series, Teikoku Taping System	Pretreat Substrate	
- Roll Temp.	50°C	2 10 27	
- Stage Temp.	40°C	Peel Cover Film	
- Speed	10 mm/sec	Laminate	
- Pressure	100 kPa	Peel Support Film	
Post Lamination Bake (on Hot-plate)	-	Expose (i-line)	
Exposure	200 mJ/cm2 (@365nm) (To obtain vertical sidewalls we recommend the use of a long-pass Optical Filter. Eliminating <350nm UV radiation)	Post Exposure Bake (PEB)  Develop	
PEB (on Hot-Plate)	45 °C / 10min + 55°C / 5min + 95 °C / 10min	Develop	
Development	Solvent Development : PGMEA 10min	Rinse and Dry	
Hard-Bake (in Oven)	60min @180°C	Hard Bake	

## PRODUCT FORMAT

Available Resist Layer Thickness :  $10\sim45~\mu m$  Resist Width : 244 mm Core Width : 270 mm

#### **SHELF LIFE**

SU-8 3000CF-05A DFR should be stored in refrigerated conditions (<15 °C) in the original packaging. Shelf-life is 6 months under refrigerated conditions.

## HANDLING PRECAUTIONS and DISPOSAL CONSIDERATIONS

Before using this product, consult the Safety Data Sheet (SDS) / Material Safety Data Sheet (MSDS) for details on the product hazards and handling precautions.

Dispose in accordance with all local, state, federal, government regulations. The material and its container must be disposed in a safe and legal manner. It is the user's responsibility to verify that treatment and disposal procedures comply with local regulations.

For further information on the use and performance of SU-8 3000CF-05A DFR, please contact your local Nippon Kayaku group representative.

## **JAPAN** (Headquarters)

Tel: +81-3-6731-5200 NIPPON KAYAKU Co., Ltd. 1-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-0005, Japan www.nipponkayaku.co.jp

#### **EUROPE**

Tel: +49-69-7191-5230 Euro NIPPON KAYAKU GmbH Staufenstrasse 4, 60323 Frankfurt am Main, Germany

#### **UNITED STATES**

Tel: +1-617-965-5511 Kayaku Advanced Materials inc 200 Flanders Road, Westborough, MA 01581, U.S.A. https://kayakuam.com

